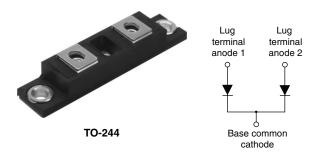
Vishay High Power Products

HEXFRED[®] Ultrafast Soft Recovery Diode, 240 A



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PRODUCT SUMMARY				
I _{F(AV)}	240 A			
V _R	400 V			
$I_{F(DC)}$ at T_C	197 A at 100 °C			

FEATURES

- Very low Q_{rr} and t_{rr}
- Lead (Pb)-free
- Designed and qualified for industrial level

BENEFITS

- · Reduced RFI and EMI
- · Reduced snubbing

DESCRIPTION

HEXFRED[®] diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dl/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Cathode to anode voltage	V _R		400	V	
Continuous forward current		T _C = 25 °C	395		
Continuous forward current I _F		T _C = 100 °C	197	А	
Single pulse forward current	I _{FSM}	Limited by junction temperature	ted by junction temperature 900		
Non-repetitive avalanche energy	E _{AS}	L = 100 μ H, duty cycle limited by maximum T _J	1.4	mJ	
Maximum namer dissignition	PD	T _C = 25 °C	658	W	
Maximum power dissipation		T _C = 100 °C	263	vv	
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		400	-	-	
		I _F = 120 A		-	1.1	1.47	v
Maximum forward voltage	V _{FM}	I _F = 240 A	See fig. 1	-	1.3	1.5	
		I _F = 120 A, T _J = 125 °C		-	1.0	1.2	
Maximum reverse leakage current	I _{RM}	$T_{J} = 125 \ ^{\circ}C, \ V_{R} = 400 \ V$	See fig. 2	-	660	5000	μΑ
Junction capacitance	CT	V _R = 200 V	See fig. 3	-	280	380	pF
Series inductance	L _S	From top of terminal hole to mounting plane - 6.0 -		nH			



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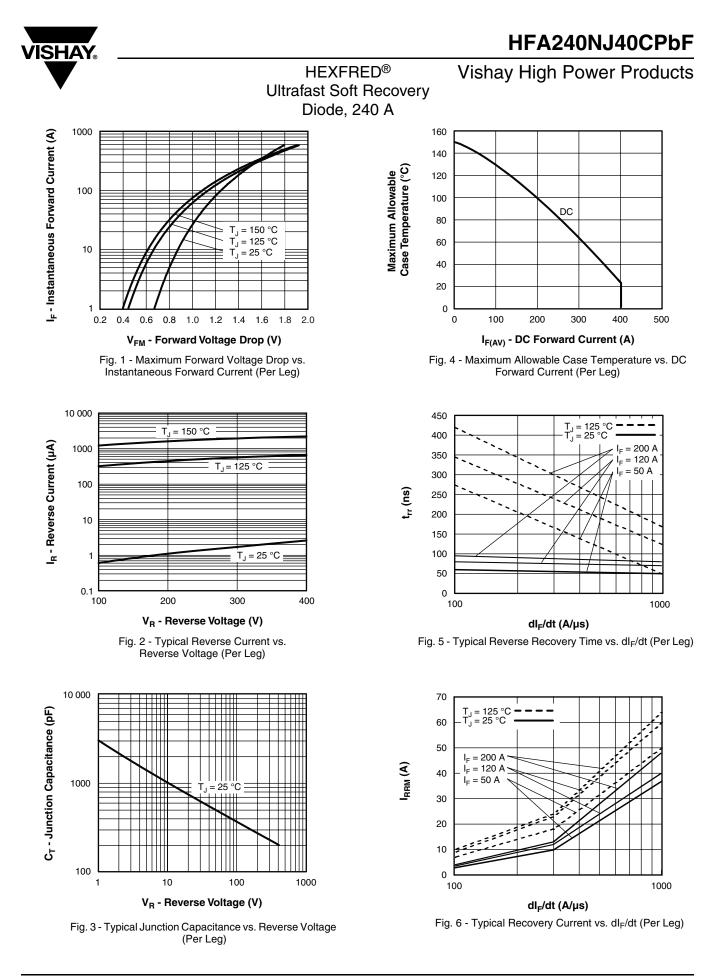
DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 2$	-	50	-		
Reverse recovery time See fig. 5	t _{rr}	T _J = 25 °C	I _F = 140 A dI _F /dt = 200 A/μs V _R = 200 V	-	77	120	ns
occ lig. o		T _J = 125 °C		-	290	440	
Peak recovery current		T _J = 25 °C		-	7.5	14	•
See fig. 6	IRRM	T _J = 125 °C		-	16	30	A
Reverse recovery charge	j Ç () _{er}	T _J = 25 °C		-	290	780	nC
See fig. 7		T _J = 125 °C		-	2300	6300	nc
Peak rate of recovery current See fig. 8	dl (dt	T _J = 25 °C		-	320	-	- A/μs
	dl _{(rec)M} /dt	T _J = 125 °C		-	270	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperatu	ire range	T _J , T _{Stg}	- 55	-	150	°C
Thermal registeres junction to asso	per leg	D	-	-	0.19	°C/W
Thermal resistance, junction to case	per module	R _{thJC}	-	-	0.095	
Typical thermal resistance, case to heatsink		R _{thCS}	-	0.10	-	7
M			-	68	-	g
Weight			-	2.4	-	oz.
Mounting torque	(1)		30 (3.4)	-	40 (4.6)	NL
Mounting torque	center hole		12 (1.4)	-	18 (2.1)	N ⋅ m (lbf ⋅ in)
Terminal torque			30 (3.4)	-	40 (4.6)	
Vertical pull 2" lever pull			-	-	80	lbf ⋅ in
			-	-	35	חויוטו

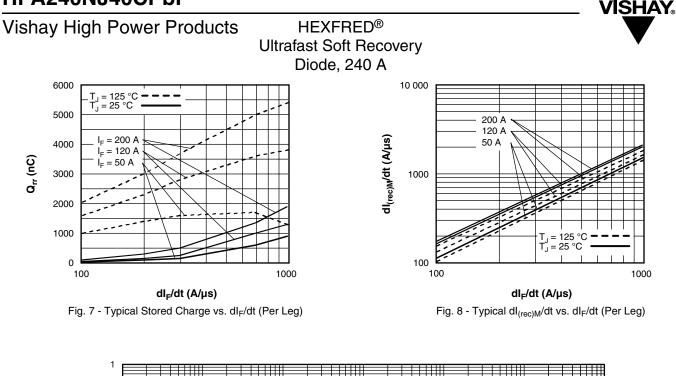
Note

(1) Mounting surface must be smooth, flat, free of burrs or other protrusions. Apply a thin even film or thermal grease to mounting surface. Gradually tighten each mounting bolt in 5 to 10 lbf · in steps until desired or maximum torque limits are reached.





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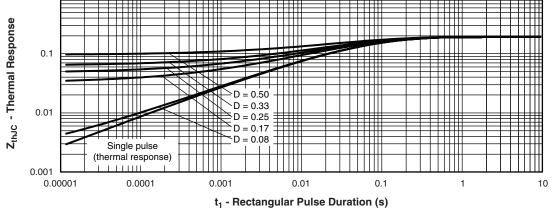
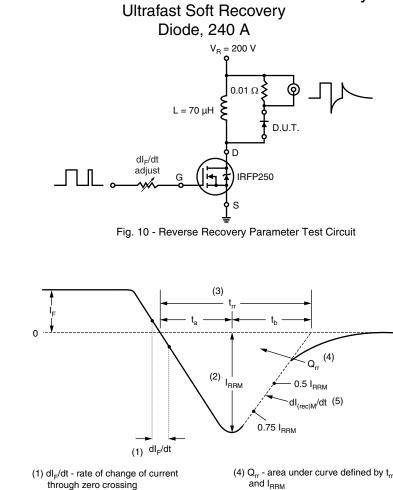


Fig. 9 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)



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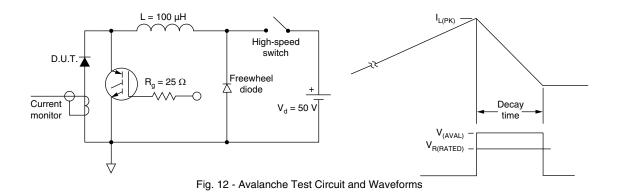


HEXFRED[®]

- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.
- and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

- (5) $dI_{(rec)M}/dt$ peak rate of change of current during t_b portion of t_{rr}
- - Fig. 11 Reverse Recovery Waveform and Definitions



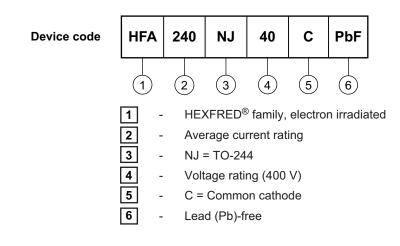
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ORDERING INFORMATION TABLE



LINKS TO RELATED DOCUMENTS			
Dimensions	http://www.vishay.com/doc?95021		

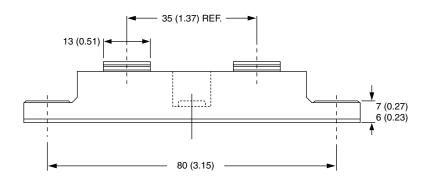


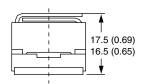
Outline Dimensions

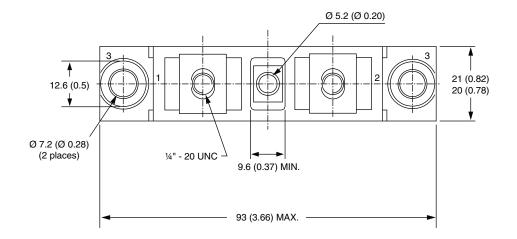
Vishay Semiconductors

TO-244

DIMENSIONS in millimeters (inches)









Vishay

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